



Opto Plus LED Corp.
0.56" Case Mold Type LED Display
OPD-T5614UPG | OPD-T5615UPG

● **EDIT HISTORY**

Version A : Mar. 14, 2024

Preliminary Spec.



Opto Plus LED Corp.

0.56" Case Mold Type LED Display

OPD-T5614UPG | OPD-T5615UPG

● FEATURES

- 0.56 inch (14.2 mm) Digit Height.
- Low current operation.
- Case mold type.
- RoHS compliant, Pb Free.

● DESCRIPTION

The device are 0.56 inch (14.2 mm) height triple digit 7-segment displays.

The device is Opto Plus LED Corp standard LED Display.

This device utilizes Pure Green LED chip which are made from InGaN on a transparent GaN substrate.

The device has face and segment option, please refer to **PRODUCT APPEARANCE**.

● DEVICE

PART NO.		DESCRIPTION
	OPD-T5614UPG-GW	Common Anode Gray face White segment
	OPD-T5615UPG-GW	Common Cathode Gray face White segment
	OPD-T5614UPG-BW	Common Anode Black face White segment
	OPD-T5615UPG-BW	Common Cathode Black face White segment

RoHS Compliance



Pb Free.

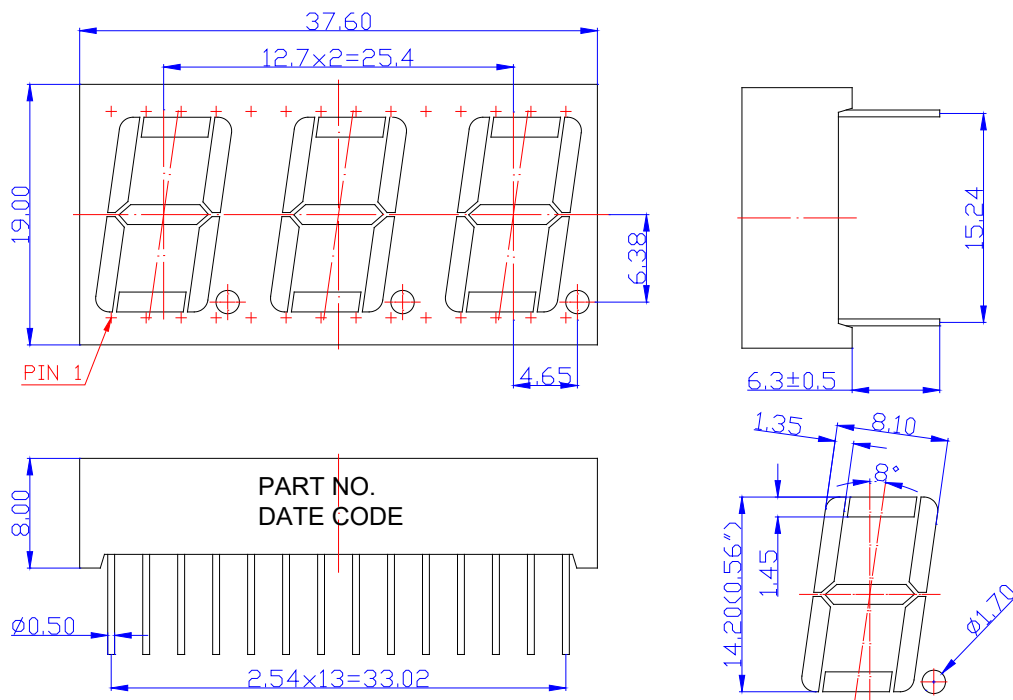


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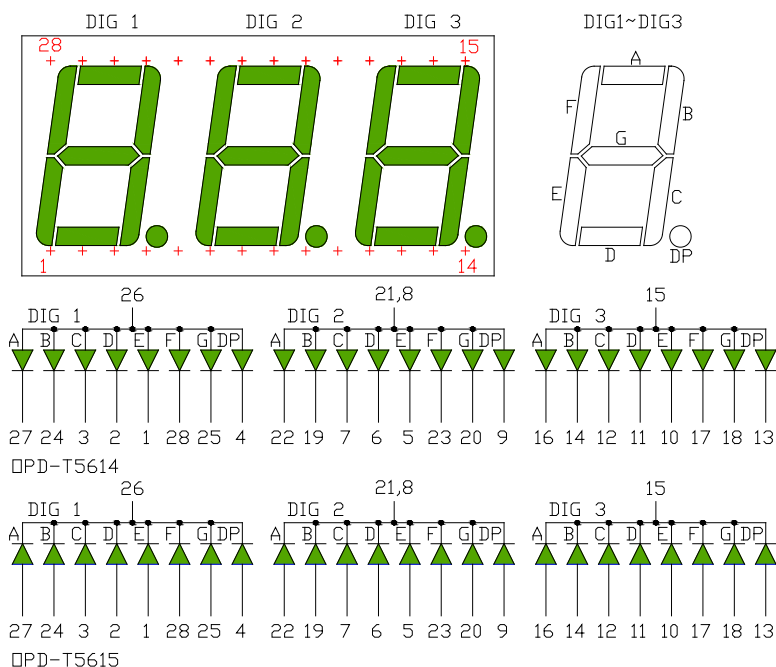
MECHANICAL DIMENSIONS



NOTES: Dimension is in millimeters. Tolerance is ± 0.25 mm unless otherwise noted.

TYPICAL INTERNAL EQUIVALENT CIRCUIT

Turn On Color



※EMITTED COLOR : PURE GREEN



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● UPG: PURE GREEN (InGaN/GaN)

ABSOLUTE MAXIMUM RATING AT Ta=25°C

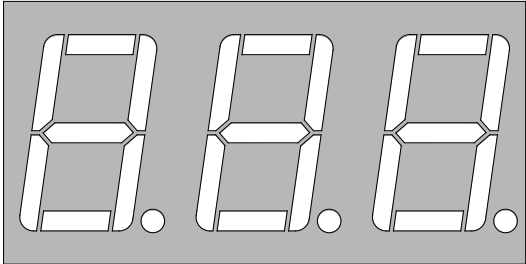
Parameter	Symbol	Maximum Rating	Unit
Power dissipation	P _{AD}	68	mW
Continuous forward current	I _{AF}	20	mA
Peak current (duty cycle 1/10, 1kHz)	I _{PF}	60	mA
Reverse voltage	V _R	5	V
Operating temperature	T _{OPR}	-40 to +85	°C
Storage temperature	T _{STG}	-40 to +85	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Type.	Max.	Unit
Forward Voltage	V _F	I _F =20mA	-	2.8	3.2	V
Reverse Current	I _R	V _R =5V	-	-	10	μA
Dominant Wavelength	λ _D	I _F =20mA	515	525	530	nm
Luminous Intensity	I _V	I _F =20mA	-	250	-	mcd
Spectral Line Half-Bandwidth	Δλ	I _F =20mA	-	30	-	nm

● PRODUCT APPEARANCE

The most common reflector color and segment color are show in below diagram.

-GW	-BW
	
※ REFLECTOR COLOR: Gray ※ SEGMENT COLOR: White	※ REFLECTOR COLOR: Black ※ SEGMENT COLOR: White

Opto Plus can customize reflector and segment colors by customer's request. If you have these request please visit www.opledtw.com or contact sales@opledtw.com for more **Standard Product Customization** information.

Part NO. related to reflector and segment colors show as table below.

PART NO.	DESCRIPTION
OPD-T5614UPG-GW	Common Anode Gray face White segment
OPD-T5615UPG-GW	Common Cathode Gray face White segment
OPD-T5614UPG-BW	Common Anode Black face White segment
OPD-T5615UPG-BW	Common Cathode Black face White segment

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● UPG: PURE GREEN (InGaN/GaN) CURVE

Typical Electro-optical Characteristic Curves
(25 °C Free Air Temperature Unless Otherwise Specified)

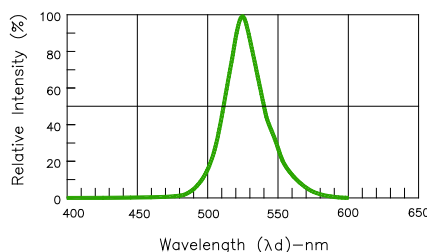


Fig.-1 Relative Intensity VS. Wavelength

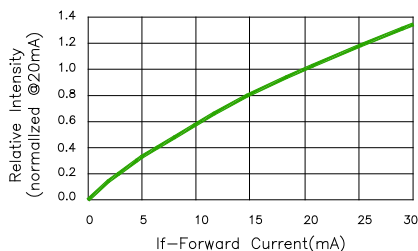


Fig.2-Relative Luminous Intensity vs. Forward Current

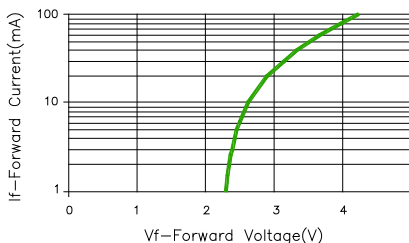


Fig.3-Forward Current vs. Forward Voltage

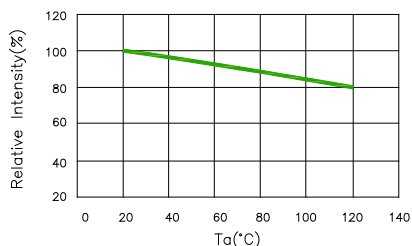


Fig.4-Relative Intensity(@20mA)VS. Ambient Temperature

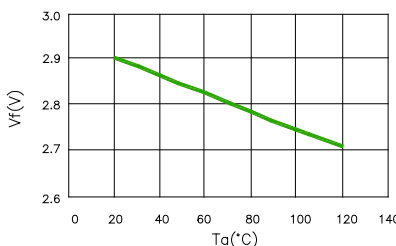


Fig.5-Forward Voltage(@20mA)VS. Ambient Temperature

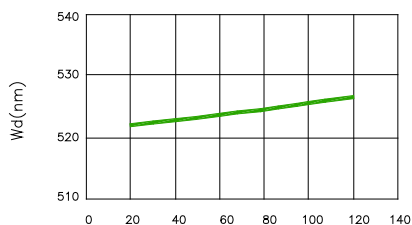


Fig.6-Dominant Wavelength(@20mA)
VS. Ambient Temperature

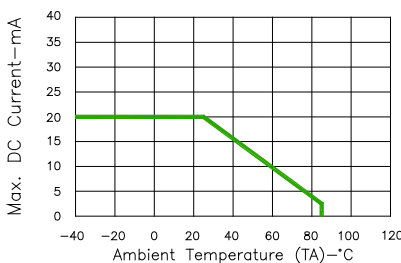
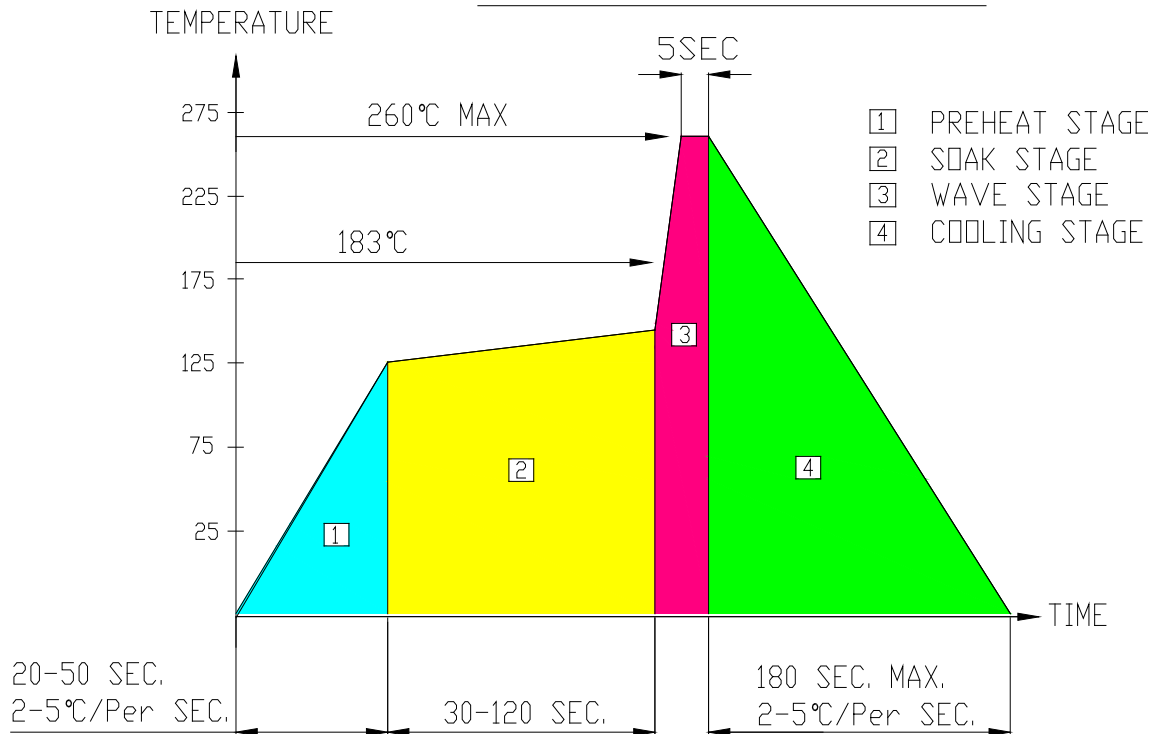


Fig.7-Max. Allowable DC Current
VS. Ambient Temperature

● RECOMMEND SOLDERING PROFILE

WAVE SOLDER PROFILE



● Note:

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- Peak wave soldering temperature between 245°C ~ 225°C for 3 sec (5 sec max)
- No more than one wave soldering pass

● SOLDERING IRON

Basic spec is ≤ 4 sec when 260°C. If temperature is higher, time should be shorter (+10°C → 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

● REWORK

Customer must finish rework within ≤ 3 sec under 350°C.
 The head of soldering iron cannot touch copper foil.